



# Bill of Materials

TI DESIGNS

ITEM	QTY	REFERENCE DESIGNATOR	VALUE	DESCRIPTION	SIZE	MANUFACTURER	MANUFACTURER PART NUMBER
1	8	C1,C2,C3,C4,C5,C6,C7,C8	.1uF	CAP CER 0.1UF 50V 20% X5R 0402	402	TDK	C1005X5R1H104M
2	2	GP1,GP2	Ground point	HOLE; 24mil-PLATED	24mil-plated		
3	1	J1	AXT580124	CONN SOCKET FPC .4MM 80POS SMD	SMT	Panasonic	AXT580124
4	1	J2	ERF5-040-01-L-D-RA	Socket Strip, 0.5mm, 80 pos Right Angle	SMT	Samtec	ERF5-040-01-L-D-RA
5	1	TP1	Testpoint	HOLE; 24mil-PLATED	24mil-plated		

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